

	HC-620T1608D-E	Spec. No.	HP-N703
	TOP VIEW RED LED	Part	LED

2003/4-Rev : 1.2

SPECIFICATION

CUSTOMER : _____

DEVICE NAME : _____

MODEL NO. : _____

ISSUED DATE : _____

[CUSTOMER APPROVAL]

APPROVAL NO.				
APPROVAL DATE				
APPROVAL	INSPECTER	CHECK	APPROVAL	COMMENT

[SUPPLIER]

ISSUED DEPT.	ISSUE	REVIEW	REVIEW	APPR'D

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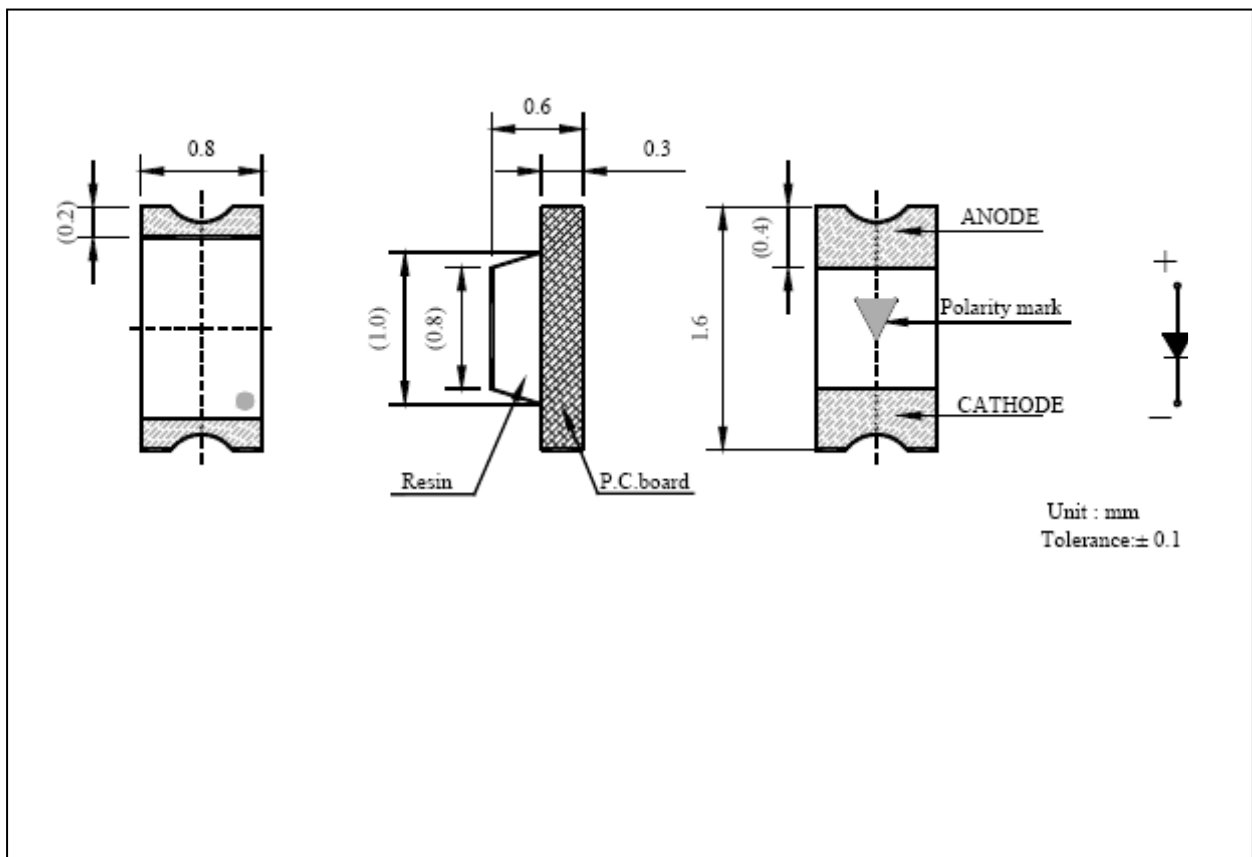
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1. FEATURES

- SMD Top View type
- Chip technology : InGaAlP
- High luminous Intensity
- Viewing angle : Lambertian emitter(120°)
- Package size : 1.6 × 0.8 × 0.6
- Reliability test completion
- Suitable for all SMT
- ESD protection



2. OUTLINE DIMENSIONS



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3. SPECIFICATIONS

■ Absolute Maximum Rating

(Ta=25°C)

Parameter	Symbol	Value	Unit
Power Dissipation	P _D	60	mW
Peak Forward Current ▶ ¹	I _{FP}	80	mA
Reverse Voltage	V _R	5	V
Forward Current	I _F	20	mA
Operating Temperature	T _{opr}	-25 to + 85	°C
Storage Temperature	T _{stg}	-30 to + 90	°C
Soldering temperature	T _{sol}	Reflow soldering : 240°C, 10 sec Hand Soldering : 300°C, 3 sec	

▶ 1 : Duty Ratio ≤ 1/10, Pulse Width ≤ 10 msec.

■ Electro-Optical Characteristics

(Ta=25°C)

Parameter	Symbol	Condition	Min	Typ	Max	Unit
Forward Voltage	V _F	I _F =20 mA	1.8		2.2	V
Reverse Current	I _R	V _R =5V	-	-	10	μA
Luminous Intensity ▶ ²	I _V	I _F =15 mA	60		130	mcd
Viewing Angle ▶ ³	2θ _{1/2}	I _F =20 mA	-	±60	-	deg.
Wavelength	λ	I _F =20 mA	-	625	-	nm

▶ 2 : Luminous intensity is measured with a light sensor and CIE eye-response curve filter combination.

▶ 3 : θ_{1/2} is the off-axis angle at which the luminous intensity is half the peak intensity.

※ Measurement Uncertainty : ± 10%.

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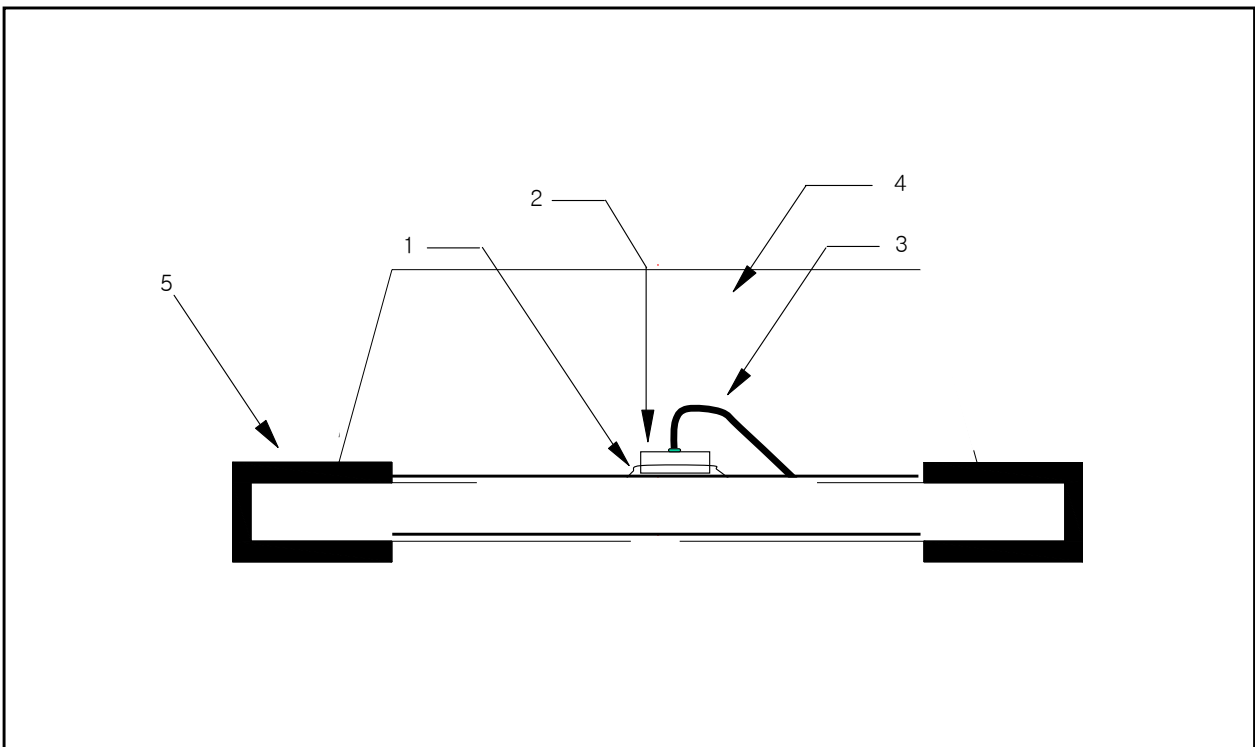
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4. COMPOSITION OF DEVICE

A. MATERIALS OF PACKAGE

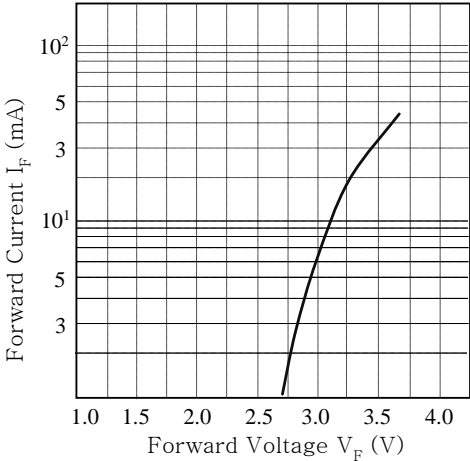
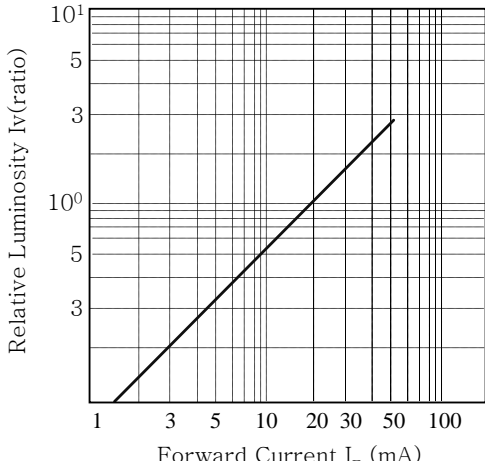
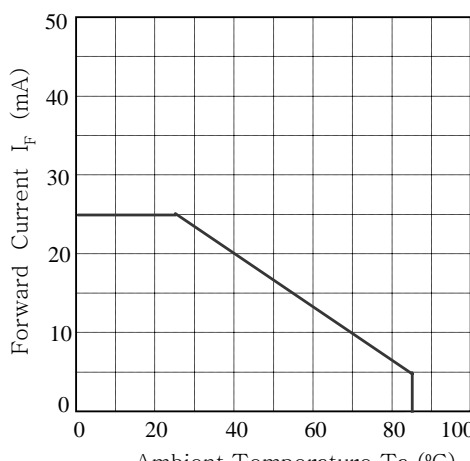
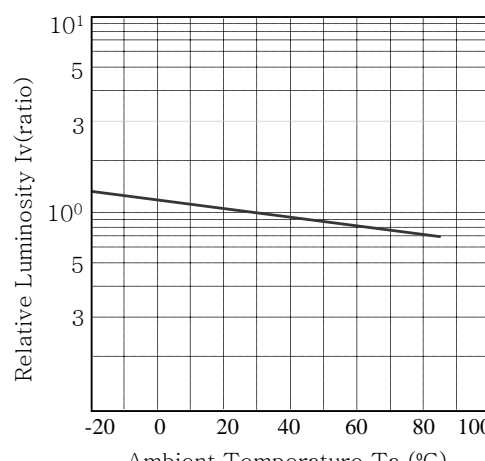
Number	Item	Material
1	Die adhesive	Ag Epoxy
2	LED Chip	InGaAlP
3	Au Wire	1.0mil
4	Mold epoxy	Epoxy Resin
5	Electrodes	Au Plating Cu Alloy

B. DIAGRAM OF COMPOSITION



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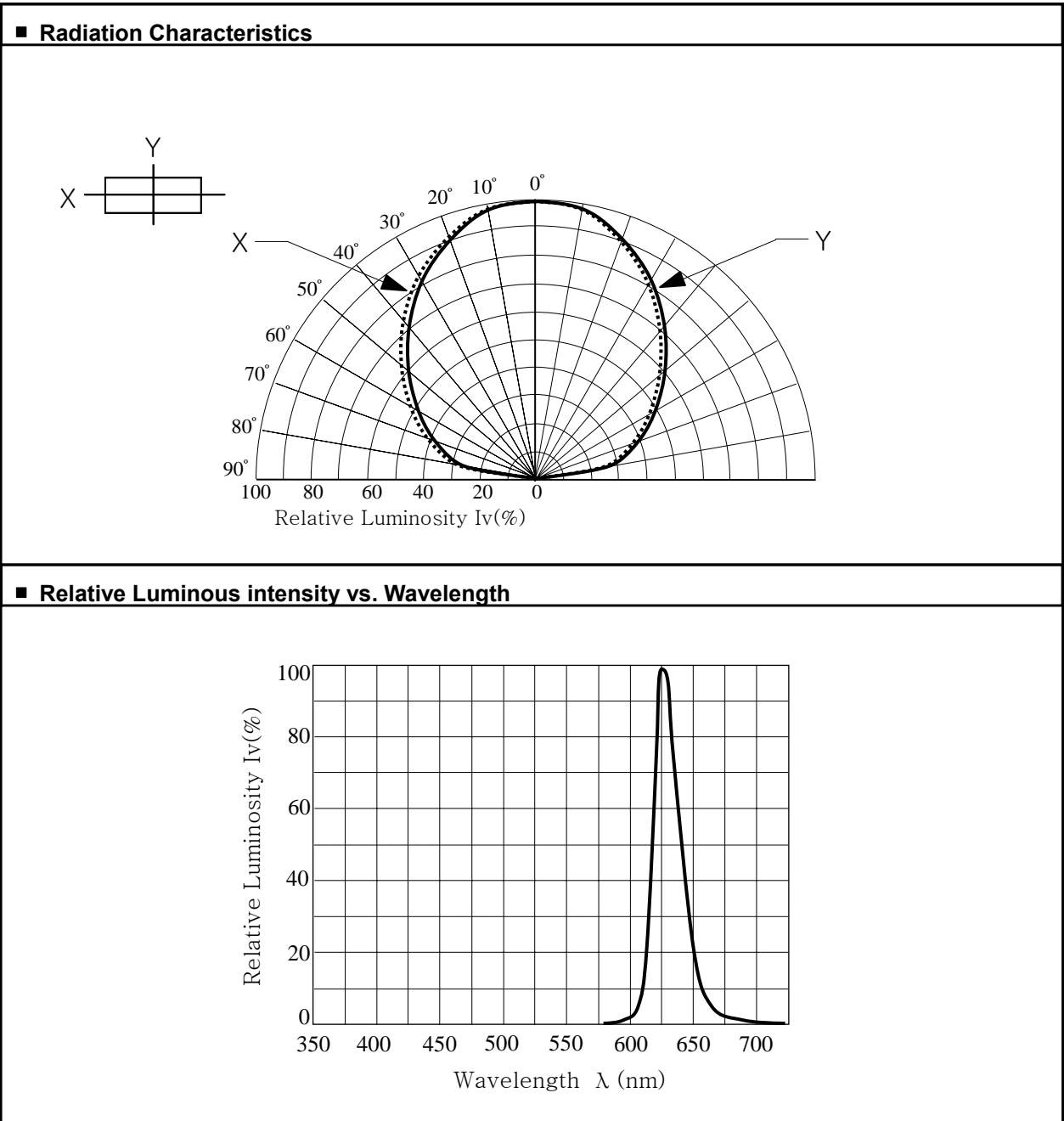
5. ELECTRO-OPTICAL CHARACTERISTICS CURVES

<p>■ Forward Voltage Vs. Forward Current</p> <p>Function : $I_F = \chi(V_F); T_A = 25^\circ\text{C}$</p> 	<p>■ Forward Current Vs. Relative Luminosity</p> <p>Function : $I_V/I_{V(20\text{mA})} = \chi(I_F); T_A = 25^\circ\text{C}$</p> 
<p>■ Forward Current Derating Curve</p> <p>Function : $I_F = \chi(T_A); I_F = I_F \text{ max}$</p> 	<p>■ Relative Luminosity Vs. Ambient T_a(°C)</p> <p>Function : $I_V/I_{V(25^\circ\text{C})} = \chi(T_A); I_F = 20\text{mA}$</p> 

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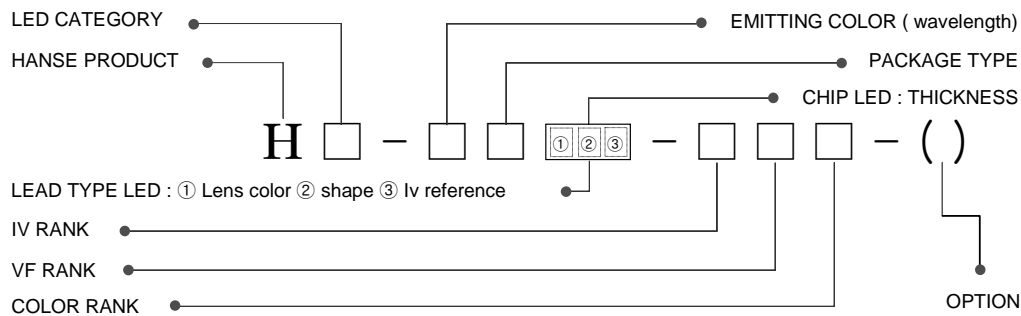
5. ELECTRO-OPTICAL CHARACTERISTICS CURVES



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6. SELECTION GUIDE : CLASSIFICATION BY NAME



LED CATEGORY

C : Chip LED

L : Lead type LED

EMITTING COLOR (wavelength)

460, 465, 470, 475, 480 : Blue

595, 600, 605 : Orange

RB1- : Red+Blue(Dual color)

500 : Cyan

610, 615, 620, 625 : Amber

RB3- : Red+Blue(Another color)

510, 515, 520, 565 : Pure Green

630, 640, 660 : Red

RGB1- : R+G+B(Full color)

570, 575 : Yellow Green

W : White (**WF : WHITE FOR FLASH**)

RGB3- : R+G+B(Another color)

580, 585, 590 : Yellow

BW : Bluish White

RM1- : Red+Yellow Green

PACKAGE TYPE

T1608 : Top View 1608

T3528 : Top View 3528

Round type : R2, R3, R4, R5, R8, R10

T1612 : Top View 16125

T5450 : Top View 5450

Flat type : F2, F3, F5

T1615 : Top View 1625

S2110 : SideView 2110 Type

Tower type : E2

T2012 : Top View 20125

S2812 : SideView 2812 Type

Oval type : O3, O4, O5

T3030 : Top View 3030

S4014 : SideView 4014 Type

Rectangular type : C4, C5

T3216 : Top View 3216

S3215 : SideView 3215 Type

Super Flux type : P7

T3530 : Top View 3530

S143 : SideView 143 Type

(Number = diameter)

Chip LED : THICKNESS : A : 0.3T, B : 0.4T, C : 0.55T, D : 0.6T, E : 0.8T, F : 1.0T, G : 2.0T, BLANK(Normal)

Lead Type LED :

① Lens Color - **2** : Milky Diffusion(M/D) / **3** : Water Clear(W/C) / **4** : Color Clear(C/C) / **5** : Colored Diffusion(C/D)

② Shape – 11 / 12 / 13 / 14 / 15/ etc : *please refer to package dimension sheet*

③ Iv reference : -H(High) / -V(Very) / -U(Ultra) / -SU(Super ultra)

IV RANK, VF RANK, COLOR RANK - Refer to rank sheet

OPTION : OPTIONAL

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7. RELIABILITY

A. TEST ITEMS AND RESULTS

Test Item	Standard test method	Test Conditions	Note	Number of Damaged
Resistance to Soldering Heat (Reflow Soldering)	JEITA ED-4701 300 301	Tsol=240℃, 10sec. (Pre treatment 30℃, 70%, 168hrs.)	2 times	0/50
Solderability (Reflow Soldering)	JEITA ED-4701 100 105	Tsol=215±5℃, 3sec.	1 time over 95%	0/50
Heat Shock	JEITA ED-4701 100 105	0℃ ~ 100℃ 5sec. 15sec.	20 cycles	0/50
Temperature Cycle	JEITA ED-4701 100 105	-40℃ ~ 25℃ ~ 100℃ ~ 25℃ 15min. 5min. 15min. 5min.	100 cycles	0/50
High Humidity Heat Cycle	JEITA ED-4701 200 203	30℃ ~ 65℃ ~ -10℃ 90%RH 24hrs./1cycle	10 cycles	0/50
High Temperature Storage	JEITA ED-4701 200 203	Ta=100℃	1000 hrs.	0/50
Humidity Heat Load	JEITA ED-4701 100 103	Ta=60℃, RH=90%	1000 hrs.	0/50
Low Temperature Storage	JEITA ED-4701 200 202	Ta=-40℃	1000 hrs.	0/50
Life Test Condition 1		Ta=25℃, IF=20mA	1000 hrs.	0/50
High Temperature Life Test		Ta=85℃, IF=5mA	1000 hrs.	0/50
High Humidity Heat Life Test		60℃, RH=90%, IF=15mA	500 hrs.	0/50
Low Temperature Life Test		Ta=-30℃, IF=20mA	1000 hrs.	0/50

B. CRITERIA FOR JUDGING THE DAMAGE

Item	Symbol	Test Conditions	Criteria for Judgement	
			Min.	Max.
Forward Voltage	VF	IF=20mA	-	U.S.L.*) × 1.1
Reverse Current	IR	VR=5V	-	U.S.L.*) × 2.0
Luminous Intensity	IV	IF=20mA	L.S.L.***) × 0.7	-

*) U.S.L. : Upper Standard Level

**) L.S.L. : Lower Standard Level

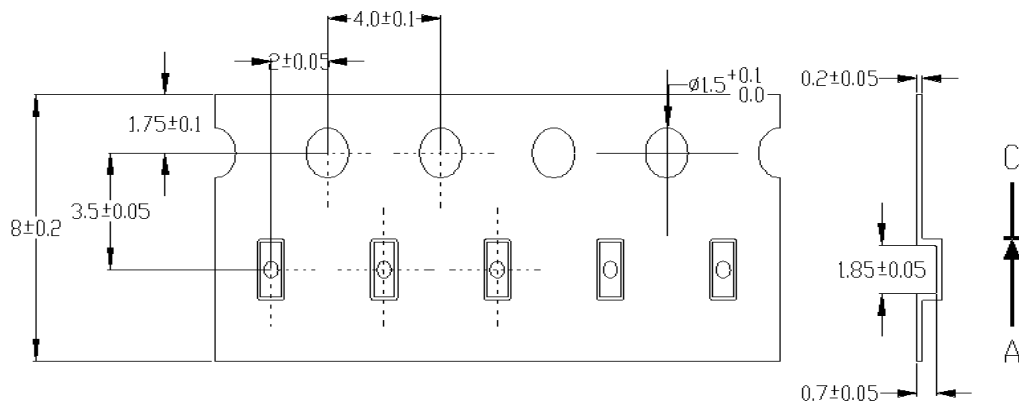
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8. TAPING

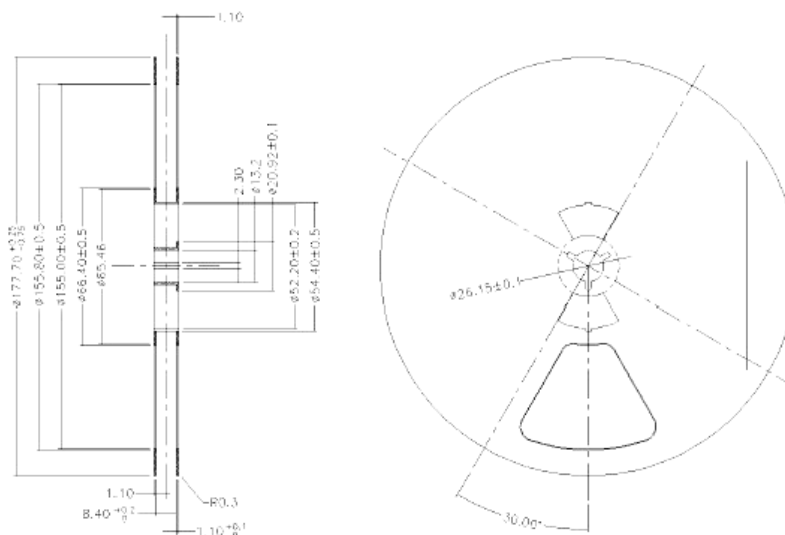
A. Dimension of Tape (Material : PS Carbon, 10E5Ω)

(Unit : mm)



B. Dimension of Wheel (Material : PS Conductive, 10E9~12Ω)

(Unit : mm)



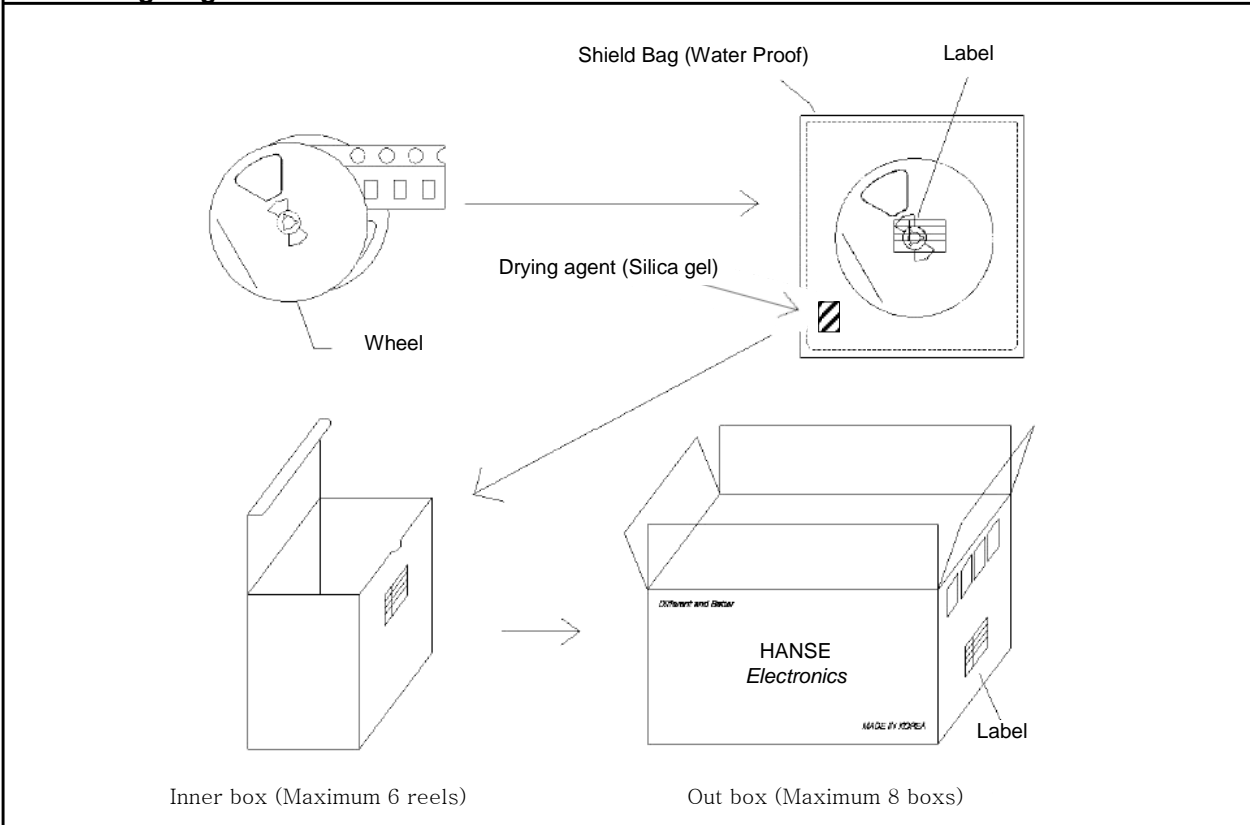
**Loading quantity
per reel
:4,000pcs**

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9. PACKING

A. Packing diagram



B. Precaution

- A. The label on the minimum packing unit shows : Part Number, Lot Number, Ranking, Quantity
In order to protect the LEDs from mechanical shock, we pack them in cardboard boxes for transportation.
- B. The LEDs may be damaged if the boxes are dropped or receive a strong impact against them, so precautions must be taken to prevent any damage.
- C. The boxes are not water resistant and therefore must be kept away from water and moisture.
When the LEDs are transported, we recommend that you use the same packing method as HANSE Electronics

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10. CAUTIONS

High Bright RED LEDs are devices which are materialized by HB Red chip.

Consequently, the color of LEDs is changed a little by an operating current.

Care should be taken after due consideration when using LEDs

(1) Moisture Proof Package

- When moisture is absorbed into the LEDs it may vaporize and expand during soldering. There is a possibility that this can cause the exfoliation of the contacts and the damage the optical characteristics of the LEDs. For this reason, the moisture proof package is used to keep moisture to a minimum in the package.
- After opening the package, the LEDs should be kept at 30℃, 40~70%RH. The LEDs should be soldered within 168 hours(7days) after opening the package.
- When storing the LEDs after opening the package, use a sealable away from package with a moisture absorbent material(Silica gel) inside.
- If the blue color of the desiccant indicator has faded after storing, a baking treatment should be performed as follows : 65 ± 5℃ for more than 24 hours.

(2) Soldering Conditions

- The LEDs can be soldered in place using the reflow soldering method.
- The recommended soldering conditions are as follows:

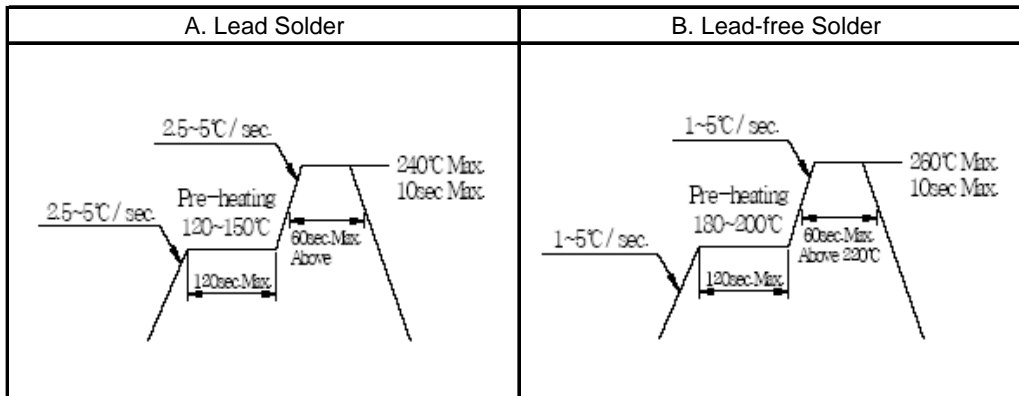
	Reflow Soldering		Hand Soldering	
	Lead Solder	Lead-free Solder	Temperature	350℃ Max 3sec Max (one time only)
Pre-heat	120~150℃	180~200℃		
Pre-heat time	120sec Max	120sec Max		
Peak temperature	240℃ Max	260℃ Max		
Soldering time	10sec Max	10sec Max		
Condition	refer to Temperature profile ①	refer to Temperature profile ②		

* After reflow soldering rapid cooling should be avoided.

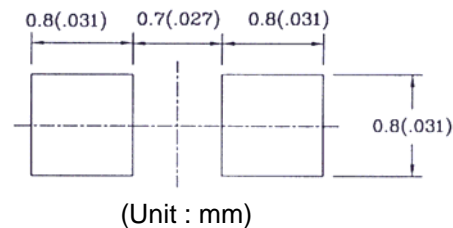
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- Temperature-Profile



- Recommended Soldering



- Modifications should not be done after the LEDs have been soldered.

If modifications cannot be avoided, a double-head soldering iron should be used after checking whether the characteristics of the LEDs will not be damaged by modification after soldering.

- Reflow soldering, do not apply force to the package during heating.
- After soldering, do not warp the circuit board.

(3) Heat Generation

- Heat generation must be taken into design consideration when using the LEDs. The coefficient of temperature increase per input electric power is about 0.62°C/mW at the LED's active layer. This coefficient will be affected by the heat resistance of the circuit board and by dense mounting of the LEDs. At the same time, precautions must be taken into the design of circuitry to avoid intense heat generation. Proper designs which allow radiation of heat, etc. may be needed.

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(4) Static Electricity

- **Static Electricity and surge damages the LEDs. It is recommended to use a wrist band or anti-electrostatic glove when handling the LEDs.**
- **All devices, equipment and machinery must be properly grounded.**
- **When inspecting own final products on which LEDs were mounted, it is recommended to check also whether the mounted LEDs are damaged by static electricity or not.**
- **Damaged LEDs will show some unusual characteristics such as leak current remarkably increases, starting forward voltage becomes lower, or the LEDs get unlighted at the low current.**

(5) Cleaning

- **Use Isopropyl Alcohol as a solvent for cleaning the LEDs. Using other solvents may dissolve the LED package and the epoxy. Caution is needed.**
Ultrasonic cleaning of the LEDs should not be done.

(6) Others

- **The electrode sections are plated with silver. Those will become discolored by contact with corroded gas etc. Precautions must be taken to maintain a clean storing atmosphere.**
- **These LEDs described in this brochure are intended to be used for ordinary electronic equipment. Consult HANSE's sales staff in advance for information on the applications in which exceptional quality and reliability are required, particularly when the failure or malfunction of the LEDs may directly jeopardize life or health (such as airplanes, aerospace, automobiles, life support systems and safety devices).**
- **User shall not reverse engineer by disassembling or analysis of the LEDs without having the prior written consent of HANSE. When defective LEDs are found, User shall inform to HANSE directly before disassembling or analysis.**
- **The appearance and specifications of the product may be modified for improvement without notice.**

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◆ BIN range

Luminous intensity (tolerance is $\pm 10\%$ @ $I_f=15\text{mA}$):

BIN CODE	Min.(mcd)	Max. (mcd)
K	60	80
L	80	100
M	100	130

Dominant Wavelength (tolerance is $\pm 2\text{nm}$ @ $I_f=15\text{mA}$):

BIN CODE	Min.(nm)	Max. (nm)
K	622	625
L	625	628
M	628	631

Forward voltage (tolerance is $\pm 0.05\text{V}$ @ $I_f=15\text{mA}$):

BIN CODE	Min.(V)	Max. (V)
F	1.8	1.9
G	1.9	2.0
H	2.0	2.1

- end -